## **MA2J7280G**

## Silicon epitaxial planar type

For super high speed switching For wave detection

#### ■ Features

- $\bullet$  Low forward voltage  $V_F$  and good wave detection efficiency  $\eta$
- Small reverse current I<sub>R</sub>
- Small temperature coefficient of forward characteristic

#### Package

- Code
- SMini2-F3Pin Name
  - 1: Anode
  - 2: Cathode

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

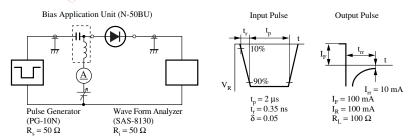
Parameter	Symbol	Rating	Unit	
Reverse voltage	$V_R$	30	V	
Maximum peak reverse voltage	$V_{RM}$	30	V	
Forward current	$I_F$	30	mA	
Peak forward current	$I_{FM}$	150	mA	
Junction temperature	Tj	125	°C	
Storage temperature	T <sub>stg</sub>	-55 to +125	°C	

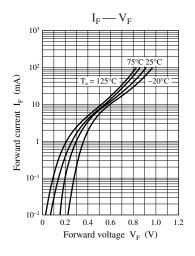
### ■ Marking Symbol: 2A

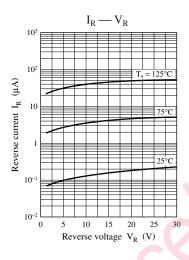
### ■ Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

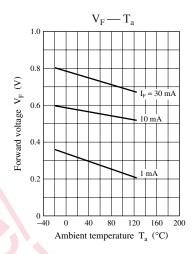
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{F1}$	$I_F = 1 \text{ mA}$			0.4	V
	$V_{F2}$	$I_F = 30 \text{ mA}$			1.0	
Reverse current	$I_R$	$V_R = 30 \text{ V}$			300	nA
Terminal capacitance	Ct	$V_R = 1 V$ , $f = 1 MHz$		1.5		pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = I_R = 10 \text{ mA}$		1.0		ns
		$I_{rr} = 1 \text{ mA}, R_L = 100 \Omega$				
Detection efficiency	η	$V_{IN} = 3 V_{(peak)}$ , $f = 30 MHz$		65		%
	" Silor	$R_L = 3.9 \text{ k}\Omega, C_L = 10 \text{ pF}$				

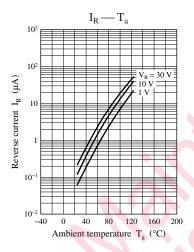
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
  - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
  - 3. Absolute frequency of input and output is 2 GHz.
  - 4. \*: t<sub>rr</sub> measurement circuit

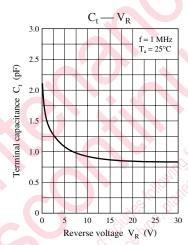


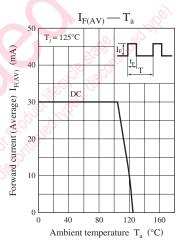






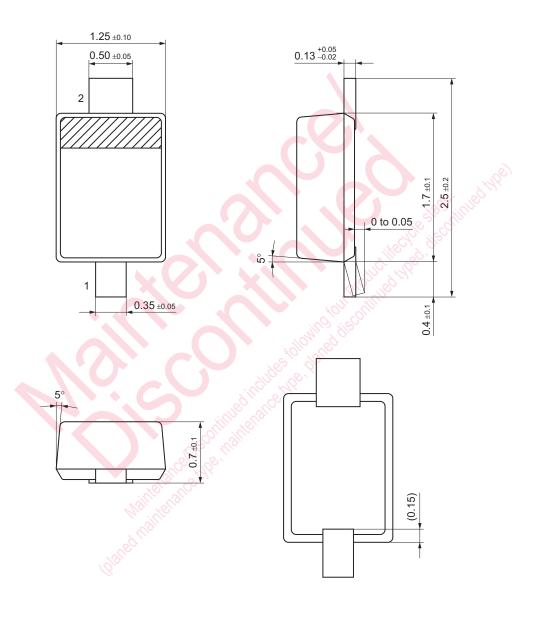






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SMini2-F3 Unit: mm



SKH00171AED 3

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